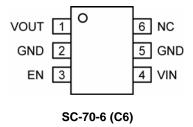
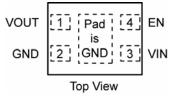
Ordering Information

Part Number		Part Marking ⁽¹⁾		Fast	Soft-	Load	Package	
Standard	Pb-Free	Standard	Pb-Free	Turn On	Start	Discharge	rackaye	
_	MIC94070YC6	_	70P	•			SC-70-6	
_	MIC94071YC6	_	71P	•		•	SC-70-6	
_	MIC94072YC6	_	72P		•		SC-70-6	
_	MIC94073YC6	_	73P		•	•	SC-70-6	
_	MIC94070YMT	_	P70	•			1.2mm x 1.6mm Thin MLF®	
_	MIC94071YMT	_	P71	•		•	1.2mm x 1.6mm Thin MLF®	
_	MIC94072YMT	_	P72		•		1.2mm x 1.6mm Thin MLF®	
_	MIC94073YMT	_	P73		•	•	1.2mm x 1.6mm Thin MLF®	

Notes

Pin Configuration





1.2x1.6 mm Thin MLF[®] (MT)

Pin Description

Pin Number		Pin Name	Pin Function			
SC-70	MLF	riii Naiile	THI T GIOGOT			
1	1	V _{OUT}	Drain of P-channel MOSFET.			
2,5	2	GND	Ground and the backside pad (MLF only) should both be connected to electrical ground.			
4	3	V _{IN}	Source of P-channel MOSFET.			
3	4	EN	Enable (Input): Active-high CMOS compatible control input for switch A. Do not leave floating.			
6		NIC	No Internal Connection. A signal or voltage applied to this pin will have no effect on device operation.			

^{1.} Under-bar symbol on SC-70 Pb-free packages may not be to scale.

Absolute Maximum Ratings (1)

Input Voltage (V _{IN})	+6V
Enable Voltage (V _{FN})	
Continuous Drain Current (I _D) (3)	
T _A = 25°C (MLF [®])	±1.2A
$T_A = 25^{\circ}C (SC-70)$	±1.2A
Pulsed Drain Current (I _{DP}) (4)	±3.0A
Continuous Diode Current (I _S) (4)	–50mA
Storage Temperature (T _s)	55°C to +150°C
Storage Temperature (T _s) ESD Rating – HBM ⁽⁶⁾	4KV

Operating Ratings (2)

Input Voltage (V _{IN})	+1.7 to +5.5V
Junction Temperature (T _J)	40°C to +125°C
Package Thermal Resistance	
SC-70-6 (θ _{JA})	
1.2 mm × 1.6 mm MLF [®] (θ_{JA})	
1.2 mm × 1.6 mm MLF [®] $(\theta_{JC})^{(3)}$	134°C/W

Electrical Characteristics

 T_A = 25°C, bold values indicate -40°C $\leq T_A \leq +85$ °C, unless noted.

Symbol	Parameter	Condition	Min	Тур	Max	Units
V_{EN_TH}	Enable Threshold Voltage	$V_{IN} = 1.8V$ to 4.5V, $I_D = -250\mu A$	0.5		1.2	V
		$V_{IN} = 1.7V \text{ to } 4.5V, I_D = -250\mu\text{A}$	0.4		1.2	V
IQ	Supply Current	$V_{IN} = V_{EN} = 5.5V$, $I_D = OPEN$		50nA	5	μA
		Measured on the V _{IN} pin (7)				
I _{EN}	Enable Input Current	$V_{IN} = V_{EN} = 5.5V$, $I_D = OPEN$		2	4	μΑ
I _{SHUT-Q}	Shutdown Current	$V_{IN} = +5.5V, V_{EN} = 0V, I_D = OPEN$		25nA	1	μΑ
		Measured on the V _{IN} pin (7)				
I _{SHUT-SWITCH}	OFF State Leakage Current	$V_{IN} = +5.5V$, $V_{EN} = 0V$, $I_D = SHORT$		50nA	1	μΑ
		Measured on V _{OUT} (7)				
R _{DS(ON)}	P-Channel Drain to Source	$V_{IN} = +5.0V, I_D = -100mA, V_{EN} = 1.5V$		120	170	mΩ
	ON Resistance	$V_{IN} = +4.5V, I_D = -100mA, V_{EN} = 1.5V$		130	185	mΩ
	SC-70 Package	$V_{IN} = +3.6V, I_D = -100mA, V_{EN} = 1.5V$		145	210	mΩ
		$V_{IN} = +2.5V, I_D = -100mA, V_{EN} = 1.5V$		165	225	mΩ
		$V_{IN} = +1.8V, I_D = -100mA, V_{EN} = 1.5V$		200	260	mΩ
		$V_{IN} = +1.7V, I_D = -100mA, V_{EN} = 1.5V$		210	285	mΩ
R _{DS(ON)}	P-Channel Drain to Source	$V_{IN} = +5.0V, I_D = -100mA, V_{EN} = 1.5V$		100	160	mΩ
	ON Resistance	$V_{IN} = +4.5V, I_D = -100mA, V_{EN} = 1.5V$		110	165	mΩ
		$V_{IN} = +3.6V, I_D = -100mA, V_{EN} = 1.5V$		125	180	mΩ
	MLF Package	$V_{IN} = +2.5V$, $I_D = -100$ mA, $V_{EN} = 1.5V$		145	200	mΩ
		$V_{IN} = +1.8V, I_D = -100mA, V_{EN} = 1.5V$		180	240	mΩ
		$V_{IN} = +1.7V, I_D = -100mA, V_{EN} = 1.5V$		190	265	mΩ
R _{SHUTDOWN}	Turn-Off Resistance	$V_{IN} = +3.6V$, $I_{TEST} = 1mA$, $V_{EN} = 0V$		200	400	Ω
		MIC94071, 73				

Electrical Characteristics (Dynamic)

 V_{IN} = 5V; T_A = 25°C, bold values indicate -40°C $\leq T_A \leq +85$ °C, unless noted.

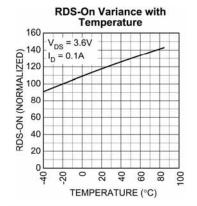
Symbol	Parameter	Condition	Min	Тур	Max	Units
t _{ON_DLY}	Turn-On Delay Time	$V_{IN} = +3.6V$, $ID = -100$ mA, $V_{EN} = 1.5V$		0.85	1.5	μs
		MIC94070, 71				
		$V_{IN} = +3.6V$, $ID = -100$ mA, $V_{EN} = 1.5V$		700	1200	μs
		MIC94072, 73				
t _{ON_RISE}	Turn-On Rise Time	$V_{IN} = +3.6V$, $ID = -100$ mA, $V_{EN} = 1.5V$	0.5	1	5	μs
		MIC94070, 71				
		$V_{IN} = +3.6V$, $ID = -100$ mA, $V_{EN} = 1.5V$	500	800	1500	μs
		MIC94072, 73				

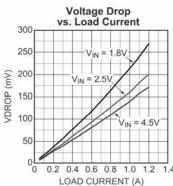
t _{OFF_DLY}	Turn-Off Delay Time	$V_{IN} = +3.6V$, $ID = -100$ mA, $V_{EN} = 1.5V$	100	200	ns
		MIC94070, 71			
		$V_{IN} = +3.6V$, $ID = -100$ mA, $V_{EN} = 1.5V$	60	200	ns
		MIC94072, 73			
t _{OFF_FALL}	Turn-Off Fall Time	$V_{IN} = +3.6V$, $ID = -100$ mA, $V_{EN} = 1.5V$	60	100	ns
		MIC94070, 71			
		$V_{IN} = +3.6V$, $ID = -100$ mA, $V_{EN} = 1.5V$	60	100	ns
		MIC94072, 73			

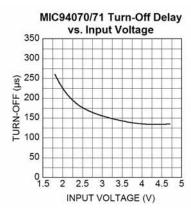
Notes:

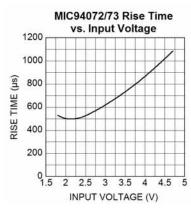
- 1. Exceeding the absolute maximum rating may damage the device.
- 2. The device is not guaranteed to function outside its operating rating.
- 3. With backside thermal contact to PCB.
- 4. Pulse width <300µs with < 2% duty cycle.
- 5. Continuous body diode current conduction (reverse conduction, i.e. V_{OUT} to V_{IN}) is not recommended.
- 6. Devices are ESD sensitive. Handling precautions recommended. HBM (Human body model), 1.5k in series with 100pF.
- 7. Measured on the MIC94070YMT, for other part numbers, please contact Micrel.

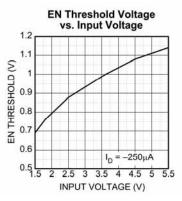
Typical Characteristics

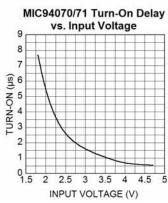


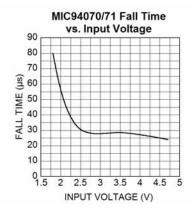


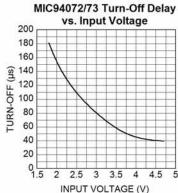


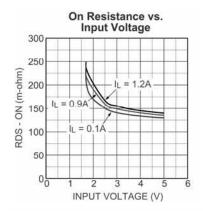


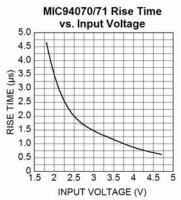


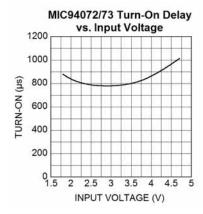


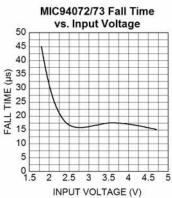




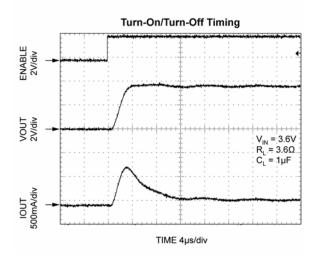


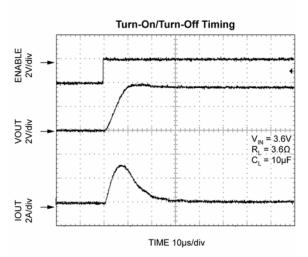


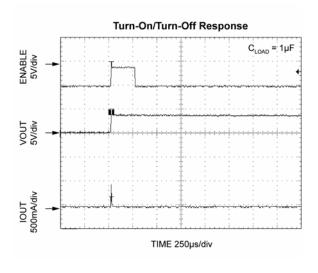


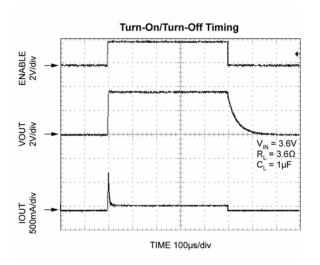


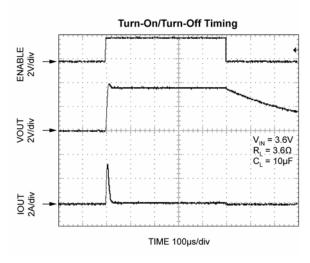
Functional Characteristics MIC94070

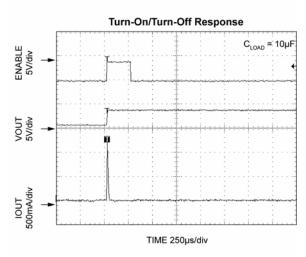




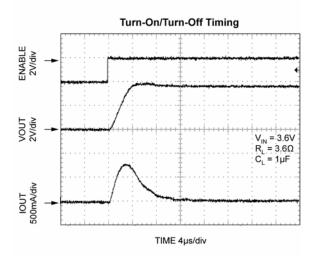


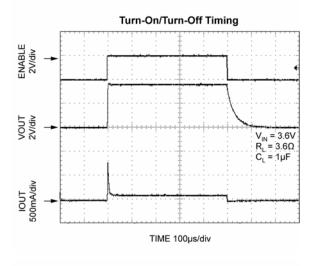


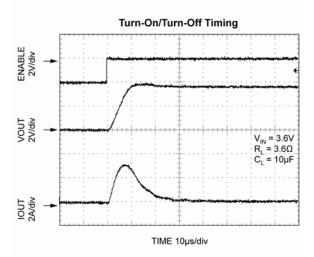


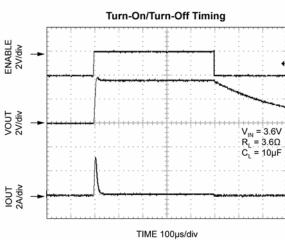


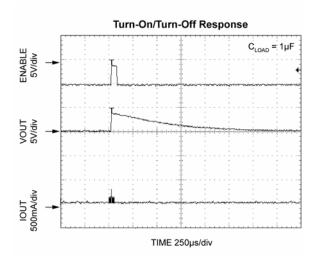
MIC94071

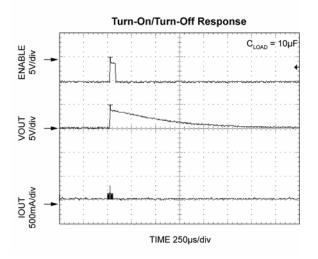




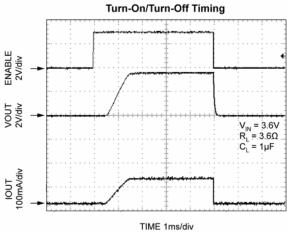


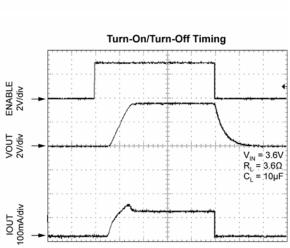




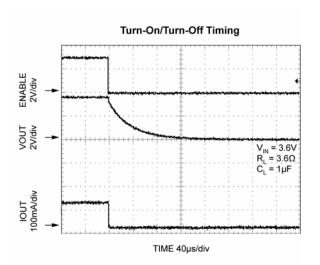


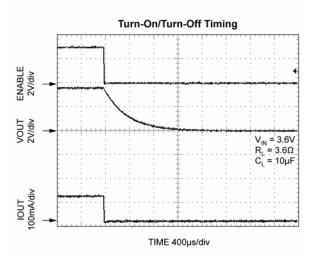
MIC94072



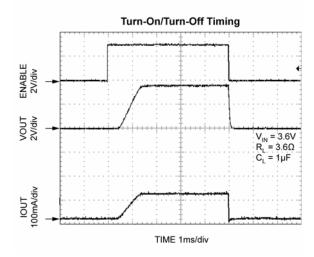


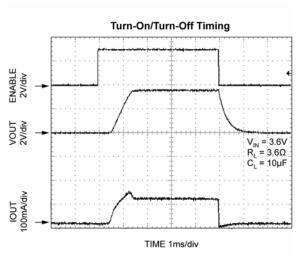
TIME 1ms/div

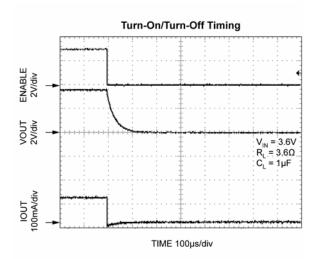


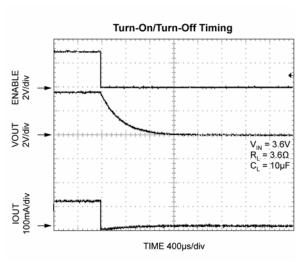


MIC94073



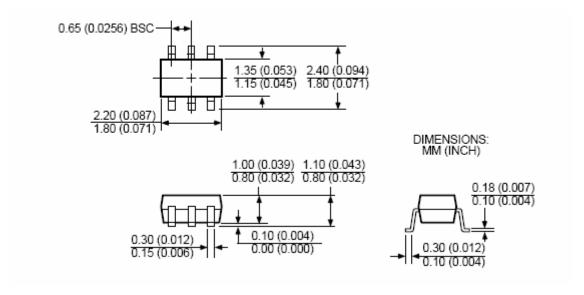




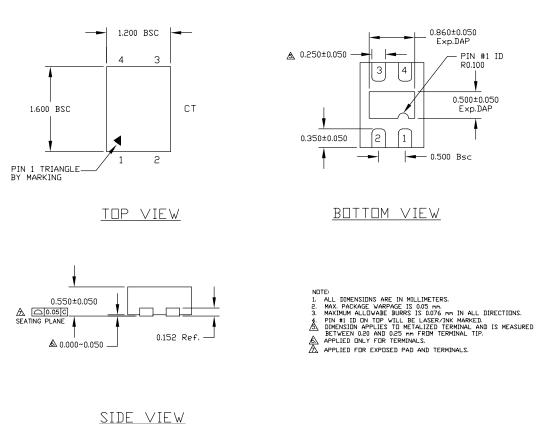


MIC94070/71/72/73 Micrel, Inc.

Package Information

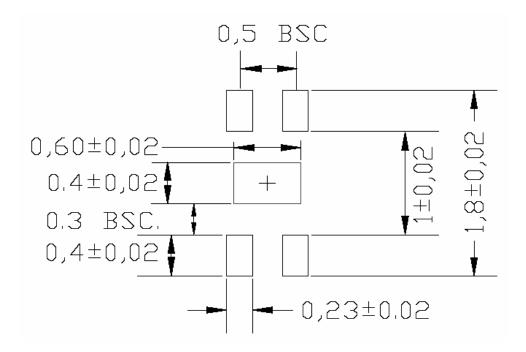


6-Pin SC-70 (C6)



4-Pin Thin MLF® (MT)

Recommended Land Pattern for MLF 1.2x1.6 4 Lead



Optional for maximum thermal performance. Heatsink should be connected to GND plane of PCB for maximum thermal performance.

Disclaimer: This is only a recommendation based on information available to Micrel from its suppliers. Actual land pattern may have to be significantly different due to various materials and processes used in PCB assembly. Micrel makes no representation or warranty of performance based on the recommended land pattern."

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